

### **SPECIFICATION SHEET**

### MHZ SMD CRYSTAL CERAMIC COVER 2 PADS XR SERIES

SPECIFICATION SHEET NO.	R1230 - XR32M00000S410							
ORIGINAL MFG/PART NO.	TGS Crystals/CMG532 32M0A30-10-30-40-30TLH							
NEXTGEN PART CODE	XR32M00000S410	Indicate This Code For RFQ/Order						
DATE	Dec. 30, 2024							
REVISION	A1 Updated With Most Recent Data							
DESCRIPTION AND	MHz SMD Crystal Glass s	eal, Ceramic Cover, 5032 Type, 2 pads, XR Series						
MAIN PARAMETRICS	Frequency stability ±30p ESR 30 ohm Max, Reflow Package in Tape/Reel, 10	30ppm, Load Capacitor 10pF pm; Operating Temp. Range -40°C ~+85°C, Profile Condition 260 °C Max.						
CUSTOMER								
CUSTOMER PART NUMBER								
CROSS REF. PART NUMBER								
МЕМО								

#### **VENDOR APPROVE**

Issued/Checked/Approved







Effective Date: Dec. 30, 2024

### **CUSTOMER APPROVE**

Date:

1



#### MHZ SMD CRYSTAL CERAMIC COVER 2 PADS XR SERIES

#### **MAIN FEATURE**

- MHz SMD Crystal, 5032 Type, L5.0\*W3.2\*H1.2mm, 2 pads
- · Glass seal, Ceramic Cover
- Low cost, High precision, High frequency stability.
- · Low Profile and Short Lead time
- RoHS/RoHS III Compliant, RoHS Annex III Lead Exemption (exempt per RoHS EU 2015/863)
- Moist are Sensitivity Level (MSL) Level 1
- Excellent Aging and Wide Frequency Range

Image shown is a representation only. Exact specifications should be obtained from the product dimension.





#### **APPLICATION**

- Bluetooth, wireless communication set
- Communication Electronics

#### **ELECTRICAL CHARACTERISTICS**

- See Page 5 ~Page 13 For Different Part Code And Rated Voltage.
- All Products Parameters are Subject To NextGen Components' Final Confirmation.

# PART CODE: **XR32M00000S410**MHZ SMD CRYSTAL CERAMIC COVER 2 PADS XR SERIES

#### **HOW TO ORDER**

• Please Follow Up Part Code Guide And Indicate NextGen Part Code XR32M00000S410 For RFQ and Order.

#### **PART CODE GUIDE**



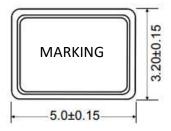
CODE	NAME	KEY SPECIFICATION OPTION
XR	Series Code	MHz SMD Crystal Glass seal, Ceramic Cover, 5032 Type, 2 pads
32M0	Frequency Range Code	32M0: 32.0MHz or Custom Frequency Range by Page 6~ Page 13
0000S	Internal Control Code	Letter A~Z, a~z or digits (0~9)
410	Parameters code	Special Parameters Code Letter A~Z, a~z or digits (1-9)
()	Special/Custom Parameters Code	Blank: N/A  XX: Letter A~Z, a~z or digits (0~9) for Special/Custom Parameters



### MHZ SMD CRYSTAL CERAMIC COVER 2 PADS XR SERIES

#### **DIMENSION** (Unit: Inch/mm)

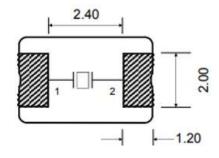
Top View



Side View



**Bottom View** 

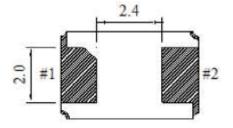


Connection

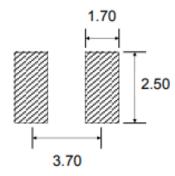
#1 Crystal #2 Crystal

or

Alternative Case Bottom View



Solder Pattern



12/30/2024 4



### MHZ SMD CRYSTAL CERAMIC COVER 2 PADS XR SERIES

#### **GENERAL SPECIFICATION**

DARAMETER	SVAADOL		VALUE		LINUT	CONDITION
PARAMETER	SYMBOL	MIN.	TYPE	MAX.	UNIT	
Frequency Range	F0	8.0000	-	54.000	MHz	Customer specified
Mode of Vibration Code			Fundame	ental		Optional: 3rd OT Or 5th OT
Frequency Tolerance	△F/F0	±10	±30	±50	ppm	at 25°C±3°C
Load Capacitance	CL	4	18	Series	pF	Customer specified
Frequency Stability	Тс	±10	±30	±50	ppm	Customer specified
Operating Temp. Range	TOPR	-40	-	+85	°C	Standard
Storage Temp. Range	Tstg	-55	-	+125	°C	
Equivalent Series Resistance	ESR		See Table 1		Ω	Customer specified
Drive Level	DL	-	100	200	μW	
Insulation Resistance	IR	500	-		mΩ	At 100VDC
Shunt Capacitance	C0	-	-	5.0	pF	
Aging per year	Fa	-3	-	+3	ppm	1st Year

#### Table 1

FREQUENCY RANGE	MODE OF VIBRATION	ESR (Ω) MAX
8.00000MHz≤ F0 <10.000MHz	Fundamental	120
0.00000IVI⊓Z≥ FU <10.000IVI⊓Z	runuamentai	120
10.000MHz≤ F0 <20.000MHz	Fundamental	80
20.000MHz≤ F0 <30.000MHz	Fundamental	40
30.000MHz≤ F0 <54.000MHz	Fundamental	30



### MHZ SMD CRYSTAL CERAMIC COVER 2 PADS XR SERIES

#### **ELECTRICAL PARAMETERS** – FOR DIFFERENT PART CODE- Ta = 25°C

PART CODE	FREQUENCY RANGE MHz	FREQUENCY TOLERANCE ppm	LOAD CAPACITANCE pF	FREQUENCY STABILITY ppm	OPERATING TEMPE. RANGE	EQUIVALENT SERIES RESISTANCE Ω Max.
XR8M000000S410	8.00000	±30	10	±30	-40~+85	120
XR8M000000S412	8.00000	±30	12	±30	-40~+85	120
XR8M000000S416	8.00000	±30	16	±30	-40~+85	120
XR8M000000S418	8.00000	±30	18	±30	-40~+85	120
XR8M000000S420	8.00000	±30	20	±30	-40~+85	120
XR8M192000S410	8.19200	±30	10	±30	-40~+85	120
XR8M192000S412	8.19200	±30	12	±30	-40~+85	120
XR8M192000S416	8.19200	±30	16	±30	-40~+85	120
XR8M192000S418	8.19200	±30	18	±30	-40~+85	120
XR8M192000S420	8.19200	±30	20	±30	-40~+85	120
XR9M216000S410	9.21600	±30	10	±30	-40~+85	120
XR9M216000S412	9.21600	±30	12	±30	-40~+85	120
XR9M216000S416	9.21600	±30	16	±30	-40~+85	120
XR9M216000S418	9.21600	±30	18	±30	-40~+85	120
XR9M216000S420	9.21600	±30	20	±30	-40~+85	120
XR9M830400S410	9.83040	±30	10	±30	-40~+85	120
XR9M830400S412	9.83040	±30	12	±30	-40~+85	120
XR9M830400S416	9.83040	±30	16	±30	-40~+85	120
XR9M830400S418	9.83040	±30	18	±30	-40~+85	120
XR9M830400S420	9.83040	±30	20	±30	-40~+85	120



### MHZ SMD CRYSTAL CERAMIC COVER 2 PADS XR SERIES

#### **ELECTRICAL PARAMETERS** – FOR DIFFERENT PART CODE- Ta = 25°C

PART CODE	FREQUENCY RANGE MHz	FREQUENCY TOLERANCE ppm	LOAD CAPACITANCE pF	FREQUENCY STABILITY ppm	OPERATING TEMPE. RANGE	EQUIVALENT SERIES RESISTANCE Ω Max.
XR10M00000S408	10.00000	±30	8	±30	-40~+85	80
XR10M00000S410	10.00000	±30	10	±30	-40~+85	80
XR10M00000S412	10.00000	±30	12	±30	-40~+85	80
XR10M00000S416	10.00000	±30	16	±30	-40~+85	80
XR10M00000S418	10.00000	±30	18	±30	-40~+85	80
XR10M00000S420	10.00000	±30	20	±30	-40~+85	80
XR11M05920S408	11.05920	±30	8	±30	-40~+85	80
XR11M05920S410	11.05920	±30	10	±30	-40~+85	80
XR11M05920S412	11.05920	±30	12	±30	-40~+85	80
XR11M05920S416	11.05920	±30	16	±30	-40~+85	80
XR11M05920S418	11.05920	±30	18	±30	-40~+85	80
XR11M05920S420	11.05920	±30	20	±30	-40~+85	80
XR12M00000S101	12.00000	±30	10	±50	-40~+85	80
XR12M00000S102	12.00000	±20	18	±30	-40~+85	80
XR12M00000S408	12.00000	±30	8	±30	-40~+85	80
XR12M00000S412	12.00000	±30	12	±30	-40~+85	80
XR12M00000S416	12.00000	±30	16	±30	-40~+85	80
XR12M00000S418	12.00000	±30	18	±30	-40~+85	80
XR12M00000S420	12.00000	±30	20	±30	-40~+85	80
XR12M28800S408	12.28800	±30	8	±30	-40~+85	80



### MHZ SMD CRYSTAL CERAMIC COVER 2 PADS XR SERIES

#### **ELECTRICAL PARAMETERS** – FOR DIFFERENT PART CODE- Ta = 25°C

		I	T			
PART CODE	FREQUENCY RANGE	FREQUENCY	LOAD CAPACITANCE	FREQUENCY STABILITY	OPERATING TEMPE. RANGE	EQUIVALENT SERIES RESISTANCE
	MHz	ppm	pF	ppm	°C	Ω Max.
XR12M28800S410	12.28800	±30	10	±30	-40~+85	80
XR12M28800S412	12.28800	±30	12	±30	-40~+85	80
XR12M28800S416	12.28800	±30	16	±30	-40~+85	80
XR12M28800S418	12.28800	±30	18	±30	-40~+85	80
XR12M28800S420	12.28800	±30	20	±30	-40~+85	80
XR13M56000S408	13.56000	±30	8	±30	-40~+85	80
XR13M56000S410	13.56000	±30	10	±30	-40~+85	80
XR13M56000S412	13.56000	±30	12	±30	-40~+85	80
XR13M56000S416	13.56000	±30	16	±30	-40~+85	80
XR13M56000S418	13.56000	±30	18	±30	-40~+85	80
XR13M56000S420	13.56000	±30	20	±30	-40~+85	80
XR14M31818S218	14.31818	±30	18	±30	-20~+70	80
XR14M31818S408	14.31818	±30	8	±30	-40~+85	80
XR14M31818S410	14.31818	±30	10	±30	-40~+85	80
XR14M31818S412	14.31818	±30	12	±30	-40~+85	80
XR14M31818S416	14.31818	±30	16	±30	-40~+85	80
XR14M31818S418	14.31818	±30	18	±30	-40~+85	80
XR14M31818S420	14.31818	±30	20	±30	-40~+85	80
XR14M74560S408	14.74560	±30	8	±30	-40~+85	80
XR14M74560S410	14.74560	±30	10	±30	-40~+85	80



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#### **ELECTRICAL PARAMETERS** – FOR DIFFERENT PART CODE- Ta = 25°C

PART CODE	FREQUENCY RANGE MHz	FREQUENCY TOLERANCE	LOAD CAPACITANCE pF	FREQUENCY STABILITY ppm	OPERATING TEMPE. RANGE	EQUIVALENT SERIES RESISTANCE Ω Max.
XR14M74560S412	14.74560	±30	12	±30	-40~+85	80
XR14M74560S416	14.74560	±30	16	±30	-40~+85	80
XR14M74560S418	14.74560	±30	18	±30	-40~+85	80
XR14M74560S420	14.74560	±30	20	±30	-40~+85	80
XR16M00000S408	16.00000	±30	8	±30	-40~+85	80
XR16M00000S410	16.00000	±30	10	±30	-40~+85	80
XR16M00000S412	16.00000	±30	12	±30	-40~+85	80
XR16M00000S416	16.00000	±30	16	±30	-40~+85	80
XR16M00000S418	16.00000	±30	18	±30	-40~+85	80
XR16M00000S420	16.00000	±30	20	±30	-40~+85	80
XR18M43200S408	18.43200	±30	8	±30	-40~+85	80
XR18M43200S410	18.43200	±30	10	±30	-40~+85	80
XR18M43200S412	18.43200	±30	12	±30	-40~+85	80
XR18M43200S416	18.43200	±30	16	±30	-40~+85	80
XR18M43200S418	18.43200	±30	18	±30	-40~+85	80
XR18M43200S420	18.43200	±30	20	±30	-40~+85	80
XR19M66080S408	19.66080	±30	8	±30	-40~+85	80
XR19M66080S410	19.66080	±30	10	±30	-40~+85	80
XR19M66080S412	19.66080	±30	12	±30	-40~+85	80
XR19M66080S416	19.66080	±30	16	±30	-40~+85	80



### MHZ SMD CRYSTAL CERAMIC COVER 2 PADS XR SERIES

#### **ELECTRICAL PARAMETERS** – FOR DIFFERENT PART CODE- Ta = 25°C

PART CODE	FREQUENCY RANGE MHz	FREQUENCY TOLERANCE	LOAD CAPACITANCE pF	FREQUENCY STABILITY ppm	OPERATING TEMPE. RANGE	EQUIVALENT SERIES RESISTANCE Ω Max.
XR19M66080S418	19.66080	±30	18	±30	-40~+85	80
XR19M66080S420	19.66080	±30	20	±30	-40~+85	80
XR20M00000S408	20.00000	±30	8	±30	-40~+85	40
XR20M00000S410	20.00000	±30	10	±30	-40~+85	40
XR20M00000S412	20.00000	±30	12	±30	-40~+85	40
XR20M00000S416	20.00000	±30	16	±30	-40~+85	40
XR20M00000S418	20.00000	±30	18	±30	-40~+85	40
XR20M00000S420	20.00000	±30	20	±30	-40~+85	40
XR22M11840S408	22.11840	±30	8	±30	-40~+85	40
XR22M11840S410	22.11840	±30	10	±30	-40~+85	40
XR22M11840S412	22.11840	±30	12	±30	-40~+85	40
XR22M11840S416	22.11840	±30	16	±30	-40~+85	40
XR22M11840S418	22.11840	±30	18	±30	-40~+85	40
XR22M11840S420	22.11840	±30	20	±30	-40~+85	40
XR24M00000S408	24.00000	±30	8	±30	-40~+85	40
XR24M00000S410	24.00000	±30	10	±30	-40~+85	40
XR24M00000S412	24.00000	±30	12	±30	-40~+85	40
XR24M00000S416	24.00000	±30	16	±30	-40~+85	40
XR24M00000S418	24.00000	±30	18	±30	-40~+85	40
XR24M00000S420	24.00000	±30	20	±30	-40~+85	40



### MHZ SMD CRYSTAL CERAMIC COVER 2 PADS XR SERIES

#### **ELECTRICAL PARAMETERS** – FOR DIFFERENT PART CODE- Ta = 25°C

			INT CODE TO - 2.			
PART CODE	FREQUENCY RANGE MHz	FREQUENCY TOLERANCE	LOAD CAPACITANCE pF	FREQUENCY STABILITY ppm	OPERATING TEMPE. RANGE	EQUIVALENT SERIES RESISTANCE Ω Max.
XR24M57600S408	24.57600	±30	8	±30	-40~+85	40
XR24M57600S410	24.57600	±30	10	±30	-40~+85	40
XR24M57600S412	24.57600	±30	12	±30	-40~+85	40
XR24M57600S416	24.57600	±30	16	±30	-40~+85	40
XR24M57600S418	24.57600	±30	18	±30	-40~+85	40
XR24M57600S420	24.57600	±30	20	±30	-40~+85	40
XR25M00000S408	25.00000	±30	8	±30	-40~+85	40
XR25M00000S410	25.00000	±30	10	±30	-40~+85	40
XR25M00000S412	25.00000	±30	12	±30	-40~+85	40
XR25M00000S416	25.00000	±30	16	±30	-40~+85	40
XR25M00000S418	25.00000	±30	18	±30	-40~+85	40
XR25M00000S420	25.00000	±30	20	±30	-40~+85	40
XR27M00000S408	27.00000	±30	8	±30	-40~+85	40
XR27M00000S410	27.00000	±30	10	±30	-40~+85	40
XR27M00000S412	27.00000	±30	12	±30	-40~+85	40
XR27M00000S416	27.00000	±30	16	±30	-40~+85	40
XR27M00000S418	27.00000	±30	18	±30	-40~+85	40
XR27M00000S420	27.00000	±30	20	±30	-40~+85	40
XR28M63636S408	28.63636	±30	8	±30	-40~+85	40
XR28M63636S410	28.63636	±30	10	±30	-40~+85	40



### MHZ SMD CRYSTAL CERAMIC COVER 2 PADS XR SERIES

#### **ELECTRICAL PARAMETERS** – FOR DIFFERENT PART CODE- Ta = 25°C

					ODEDATING	FOLUNAL FAIT
	FREQUENCY	FREQUENCY	LOAD	FREQUENCY	OPERATING TEMPE.	EQUIVALENT SERIES
PART CODE	RANGE	TOLERANCE	CAPACITANCE	STABILITY	RANGE	RESISTANCE
	MHz	ppm	pF	ppm	°C	Ω Max.
XR28M63636S412	28.63636	±30	12	±30	-40~+85	40
XR28M63636S416	28.63636	±30	16	±30	-40~+85	40
XR28M63636S418	28.63636	±30	18	±30	-40~+85	40
XR28M63636S420	28.63636	±30	20	±30	-40~+85	40
XR30M00000S408	30.00000	±30	8	±30	-40~+85	30
XR30M00000S410	30.00000	±30	10	±30	-40~+85	30
XR30M00000S412	30.00000	±30	12	±30	-40~+85	30
XR30M00000S416	30.00000	±30	16	±30	-40~+85	30
XR30M00000S418	30.00000	±30	18	±30	-40~+85	30
XR30M00000S420	30.00000	±30	20	±30	-40~+85	30
XR32M00000S408	32.00000	±30	8	±30	-40~+85	30
XR32M00000S410	32.00000	±30	10	±30	-40~+85	30
XR32M00000S412	32.00000	±30	12	±30	-40~+85	30
XR32M00000S416	32.00000	±30	16	±30	-40~+85	30
XR32M00000S418	32.00000	±30	18	±30	-40~+85	30
XR32M00000S420	32.00000	±30	20	±30	-40~+85	30
XR40M00000S408	40.00000	±30	8	±30	-40~+85	30
XR40M00000S410	40.00000	±30	10	±30	-40~+85	30
XR40M00000S412	40.00000	±30	12	±30	-40~+85	30
XR40M00000S416	40.00000	±30	16	±30	-40~+85	30



### MHZ SMD CRYSTAL CERAMIC COVER 2 PADS XR SERIES

#### **ELECTRICAL PARAMETERS** – FOR DIFFERENT PART CODE- Ta = 25°C

	FREQUENCY	FREQUENCY	LOAD	FREQUENCY	OPERATING	EQUIVALENT
PART CODE	RANGE	TOLERANCE	CAPACITANCE	STABILITY	TEMPE.	SERIES
			_		RANGE	RESISTANCE
	MHz	ppm	pF	ppm	°C	Ω Max.
XR40M00000S418	40.00000	±30	18	±30	-40~+85	30
XR40M00000S420	40.00000	±30	20	±30	-40~+85	30
XR48M00000S410	48.00000	±30	10	±30	-40~+85	30
XR48M00000S412	48.00000	±30	12	±30	-40~+85	30
XR48M00000S416	48.00000	±30	16	±30	-40~+85	30
XR48M00000S418	48.00000	±30	18	±30	-40~+85	30
XR48M00000S420	48.00000	±30	20	±30	-40~+85	30
XR50M00000S410	50.00000	±30	10	±30	-40~+85	30
XR50M00000S412	50.00000	±30	12	±30	-40~+85	30
XR50M00000S416	50.00000	±30	16	±30	-40~+85	30
XR50M00000S418	50.00000	±30	18	±30	-40~+85	30
XR50M00000S420	50.00000	±30	20	±30	-40~+85	30



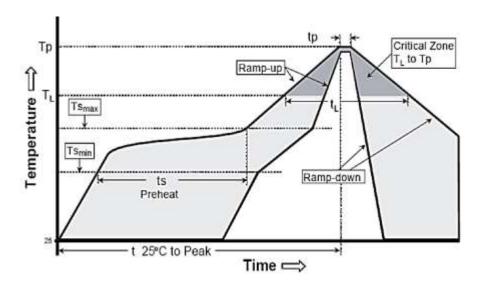
### MHZ SMD CRYSTAL CERAMIC COVER 2 PADS XR SERIES

#### **RELIABILITY** (MECHANICAL AND ENVIRONMENTAL ENDURANCE)

TEST ITEMS	TEST METHOD AND CONDITIONS	REQUIREMENTS
High Temperature High	Temperature: 85°C±3°C	JIS C5023
Humidity Storage	Relative Humidity:85%RH	
	Time: 96 Hours	
High Temperature Storage	Temperature: 125°C±3°C	MIL-STD-883E
	Time: 96 Hours.	Method 1005.8
Low Temperature Storage	Temperature: -40°C±3°C	MIL-STD-883E
	Time: 96 Hours.	Method 1013
Thermal Shock	Temperature 1: -55°C±5°C	MIL-STD-202F
	Temperature 2: 85°C±5 °C	Method 107
	Temperature change between T1 and T2 5 min	Condition A
	10cycles maintain T1 and T2 for 30 minutes each cycle	
Resistance to Solder Heat	Solder Temperature: 260°C±5°C	MIL-STD-202F
	Time: 10±1 Seconds	Method 210E
Solderability	The solder pot temperature is 245±5°C , dwell time	J-STD-002B
	5±0.5sec	
Drop Test	3 Times Free Fall from 50cm height table to 3cm	J-STD-002B
	thickness hard wood board	
Mechanical Shock	Half sine wave,1000 G	MIL STD 202F
	3 Times for all 3 directions(X,Y Z)	Method 213B
Vibration	Frequency Range: 10Hz ~ 55Hz	MIL-STD-883E
	Amplitude: 0.75mm	Method 2007.3
	2 Hours in each direction, total 6 Hours	
Leakage Test	Take measurements with a helium	MIL-STD-883E
	Leakage detector	
	Leakage Rate≤1×10 <sup>-3</sup> Pa cm³/s	



#### SUGGESTED REFLOW PROFILE (For Reference Only)

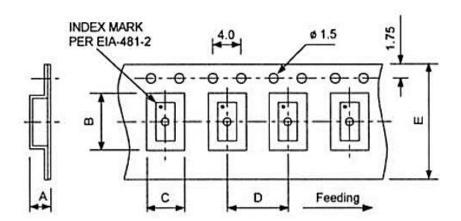


PROFILE FEATURE		PB-FREE ASSEMBLY
Average Ramp-up Rate (Ts Max to Tp)		3°C/second Max
Preheat	Temperature Min (Ts Min.)	125°C
	Temperature Max (Ts Max.)	200°C
	Time (ts Min. to ts Max.)	60 ~ 180 seconds
Time maintained above	Temperature (TL)	217°C
	Time (tL)	60 ~ 150 seconds
Peak/Classification Temperature (Tp)		260 °C
Time within 5°C of actual Peak Temperature (tp)		20 ~ 40 seconds
Ramp-down rate		6 °C /Second Max.
Time 25 °C to Peak Temperature		8 minutes Max.
Suggest reflow times		3 Times Max.

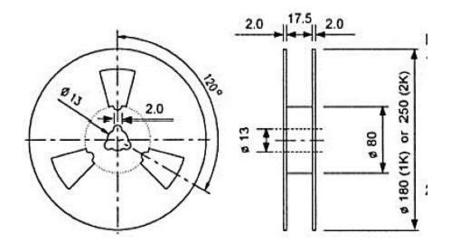


TAPE AND REEL (1000pcs/Reel, Unit: mm)

All Devices are packed in accordance with EIA standard RS-481-2 and specifications., 1000pcs/Reel



ITEM	DIMENSION
А	1.70
В	5.45
С	3.65
D	8.00
E	12.0



# PART CODE: **XR32M00000S410**MHZ SMD CRYSTAL CERAMIC COVER 2 PADS XR SERIES

#### **IMPORTANT NOTES AND DISCLAIMER**

- ROHS COMPLIANCE: The levels of RoHS restricted materials in this product are below the maximum
  concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an
  exempted application, in accordance with EU RoHS Directive (EU) 2015/863 EC (RoHS3). RoHS Test Report for
  this product can be obtained can be obtained at Download Center.
- REACH COMPLIANCE: REACH substances of high concern (SVHCs) information is available for this product.
   Since the European Chemical Agency (ECHA) has published notice of their intent to frequently revise the SVHC listing for the foreseeable future, REACH Test Report for this product can be obtained at Download Center.
- All Product parametric performance is indicated in the Electrical Characteristics for the listed herein test
  conditions, unless otherwise noted. Product performance may not be indicated by the Electrical
  Characteristics if operated under different conditions.
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